


**APPLICATION DATA SHEET**

Electronic Version v14

Stylesheet Version v14.0

<b>Title of Invention</b>	[STRUCTURE APPLIED TO A PHOTOLITHOGRAPHIC PROCESS AND METHOD FOR FABRICATING A SEMICONDUCTOR DEVICE]		
<b>Application Type :</b>		regular, utility	
<b>Attorney Docket Number :</b>		12398-US-PA	
<b>Correspondence address:</b>			
<b>Customer Number:</b>	31561		
<b>Inventors Information:</b>			
<u>Inventor 1:</u>			
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as our attorney(s) or agent(s) to prosecute the application identified above, and to transact all business in the United States Patent and Trademark Office connected therewith.